Material Composition Declar © Copyright 2005. IPC, Bannockburn international and Pan-American copyr				urn, Illinois. All rights reserved under both			This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
1752-21.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x				lard	Form Type * Declaration Class * Distribute Class 6 - RoHS Yes/No, Homogeneous Mate				Homogeneous Mater	rials and Mfg Information					
Supplier	r Informa	tion														
Company name*			Company unique ID				Unique ID Authority					Response Date*				
onsemi												2024-05-15				
Contact Name				Title - Contac	Title - Contact				Phone - Contact*				Email - Contact*			
Product-E	Product-Env-Stewards				Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized	Authorized Representative*				Title - Representative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item			Number Mfr Item Name				Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	NCV712			0FP0R2G NCV7120FP0R2G - N120 NAI			NCV7120	2024-05-15		P	PHG		278.97	mg	Each	
Manufacturing Process Information																
	Terminal Plating / Grid Array Material T			Ferminal Base Alloy J-STD-020 MS			L Rating	Peak Process Body Temperature Max Time at Pea			k Temperature Number of Reflow Cycles					
	Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 3		3		260 C		С	30 seco		econds 3			
Comments																
ATTENTION: MSL 3 Rated item requires Bake and Dry Pack (after electrical test)																
For more information regarding material composition please refer to page 3																

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	11.87	mg	Supplier	Silicon (Si)	7440-21-3		11.87	mg
Die Attach	9.32	mg	Supplier	Silver (Ag)	7440-22-4		6.99	mg
			Supplier	Epoxy resins	129915-35-1		2.33	mg
Lead Frame	100.03	mg	Supplier	Zinc (Zn)	7440-66-6		0.2001	mg
			Supplier	Chromium (Cr)	7440-47-3		0.3001	mg
			Supplier	Copper (Cu)	7440-50-8		99.5298	mg
Mold Compound-Black	151.43	mg		Epoxy Phenol Resin	proprietary data		17.3539	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		134.0761	mg
Plating	3.7	mg	Supplier	Tin (Sn)	7440-31-5		3.7	mg
Wire Bond - Au	2.62	mg	Supplier	Gold (Au)	7440-57-5		2.62	mg